

STP27N60M2-EP, STW27N60M2-EP

N-channel 600 V, 0.150 Ω typ., 20 A MDmesh[™] M2 EP Power MOSFETs in TO-220 and TO-247 packages

Datasheet - production data

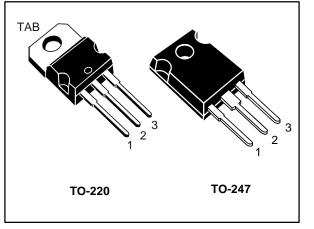
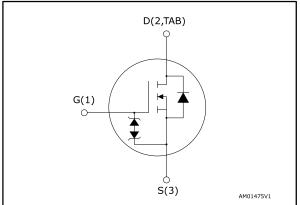


Figure 1: Internal schematic diagram



Features

Order code	V ds	R _{DS(on)} max	ΙD
STP27N60M2-EP	600 V	0.163 Ω	20 A
STW27N60M2-EP	600 V	0.163 Ω	20 A

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- Very low turn-off switching losses
- 100% avalanche tested
- Zener-protected

Applications

- Switching applications
- Tailored for very high frequency converters (f > 150 kHz)

Description

These devices are N-channel Power MOSFETs developed using MDmesh[™] M2 EP enhanced performance technology. Thanks to their strip layout and an improved vertical structure, these devices exhibit low on-resistance, optimized switching characteristics with very low turn-off switching losses, rendering them suitable for the most demanding very high frequency converters.

Table 1: Device summary

Order code	Marking	Package	Packaging				
STP27N60M2-EP		TO-220	Tuba				
STW27N60M2-EP	27N60M2EP	TO-247	Tube				

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	± 25	V
ID	Drain current (continuous) at $T_c = 25 \ ^{\circ}C$	20	А
lo	Drain current (continuous) at T _c = 100 °C	13	А
IDM ⁽¹⁾	Drain current (pulsed)	80	А
P _{TOT}	Total dissipation at $T_C = 25 \text{ °C}$	170	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	15	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature	55 to 150	°C
Tj	Operating junction temperature	- 55 to 150	C

Notes:

⁽¹⁾Pulse width limited by safe operating area.

 $^{(2)}I_{SD} \leq$ 20 A, di/dt \leq 400 A/µs; V_DS(peak) < V(BR)DSS, V_DD = 400 V. $^{(3)}V_{DS} \leq$ 480 V

Table 3: Thermal data

Symbol	Parameter	Va	Unit		
Symbol	Falameter	TO-220	TO-247	Unit	
Rthj-case	Thermal resistance junction-case max	0.74		°C/W	
$R_{thj-amb}$	Thermal resistance junction-ambient max	62.5 50		°C/W	

Table 4: Avalanche characteristics

Symbol	Parameter		Unit
I _{AR}	Avalanche current, repetetive or not repetetive (pulse width limited by T_{jmax})	3.6	А
Eas	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$; $V_{DD} = 50$ V)	260	mJ



2 Electrical characteristics

 $T_c = 25$ °C unless otherwise specified

Table 5: On/off states						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	600			V
IDSS	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 600 V$			1	μA
		$V_{GS} = 0 V, V_{DS} = 600 V,$ $T_{C} = 125 \ ^{\circ}C$			100	μA
I _{GSS}	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = ±25 V			±10	μA
V _{GS(th)}	Gate threshold voltage	V_{DS} = V_{GS} , I_D = 250 μ A	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	V_{GS} = 10 V, I_{D} = 10 A		0.150	0.163	Ω

Table 6: Dynamie	C
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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1320	-	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	70	-	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V	-	1	-	pF
Coss eq. ⁽¹⁾	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	-	146	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	4	-	Ω
Qg	Total gate charge	$V_{DD} = 480 \text{ V}, I_D = 20 \text{ A},$	-	33	-	nC
Qgs	Gate-source charge	V _{GS} = 10 V (see Figure 17: "Test circuit for gate charge behavior")	-	5.2	-	nC
Q _{gd}	Gate-drain charge		-	16	-	nC

Notes:

 $^{(1)}C_{\text{oss eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 10 \text{ A},$	-	13.4	-	ns
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 16: "Test circuit for	-	8.1	-	ns
t _{d(off)}	Turn-off-delay time	resistive load switching times"	-	55.6	-	ns
t _f	Fall time	and Figure 21: "Switching times" waveform")	-	6.3	-	ns



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Electrical characteristics

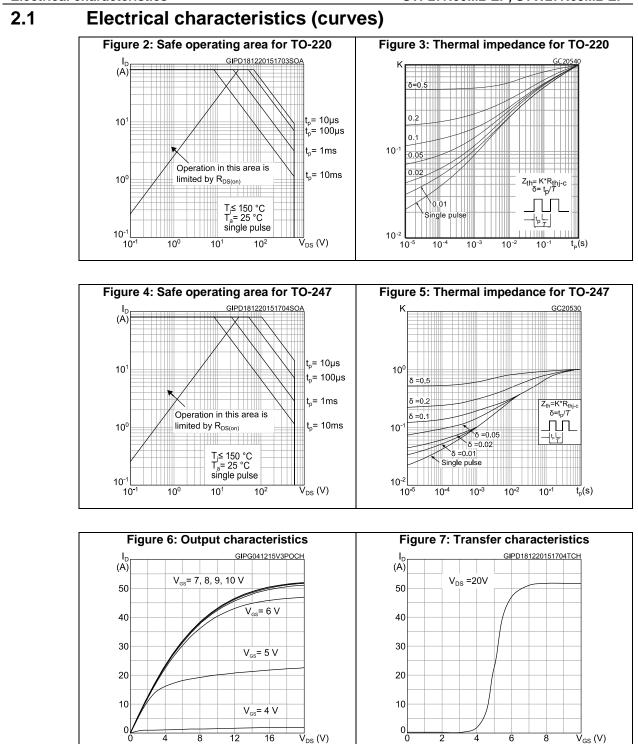
Table 8: Source-drain diode									
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit			
Isd	Source-drain current		-		20	А			
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		80	А			
Vsd ⁽²⁾	Forward on voltage	V _{GS} = 0 V, I _{SD} = 20 A	-		1.6	V			
trr	Reverse recovery time	I _{SD} = 20 A, di/dt = 100 A/µs,	-	271		ns			
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}$ (see Figure 21:	-	3.44		μC			
Irrm	Reverse recovery current	"Switching time waveform")	-	25.4		А			
t _{rr}	Reverse recovery time	I _{SD} = 20 A, di/dt = 100 A/µs,	-	352		ns			
Qrr	Reverse recovery charge	V _{DD} = 60 V, T _j = 150 °C (see <i>Figure 21: "Switching time</i>	-	4.82		μC			
IRRM	Reverse recovery current	waveform")	-	27.4		А			

Notes:

 $^{(1)}\mbox{Pulse}$ width is limited by safe operating area

 $^{(2)}\text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

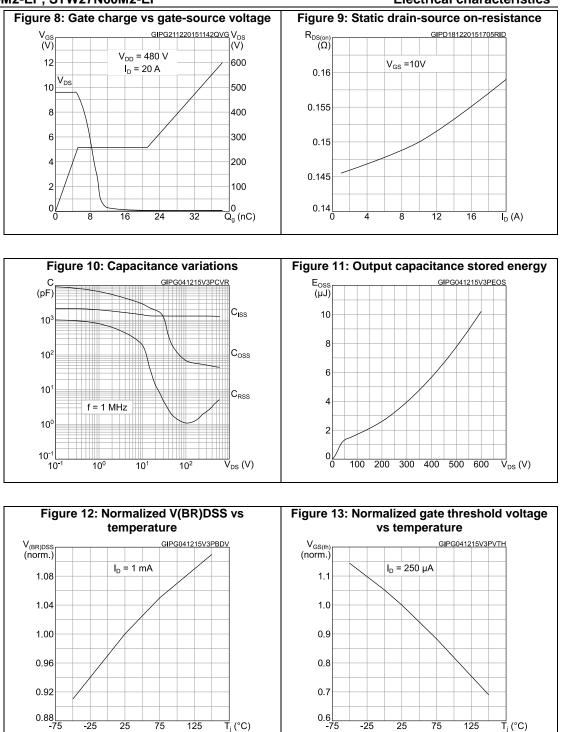






STP27N60M2-EP, STW27N60M2-EP

Electrical characteristics



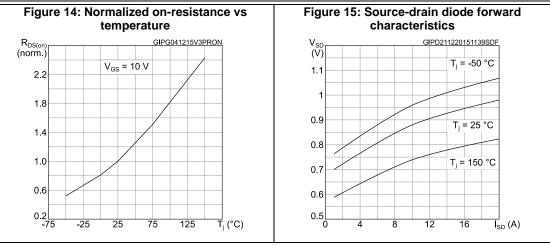
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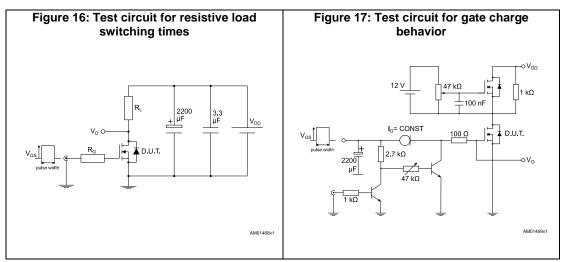
Electrical characteristics

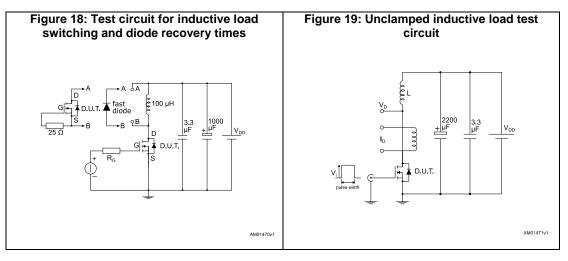
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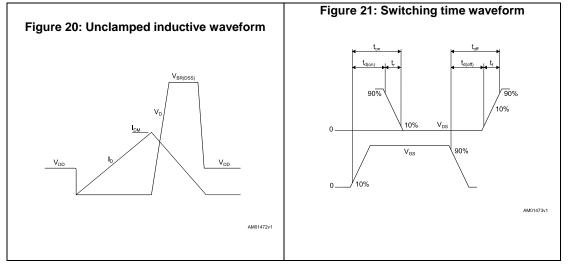




3 Test circuits







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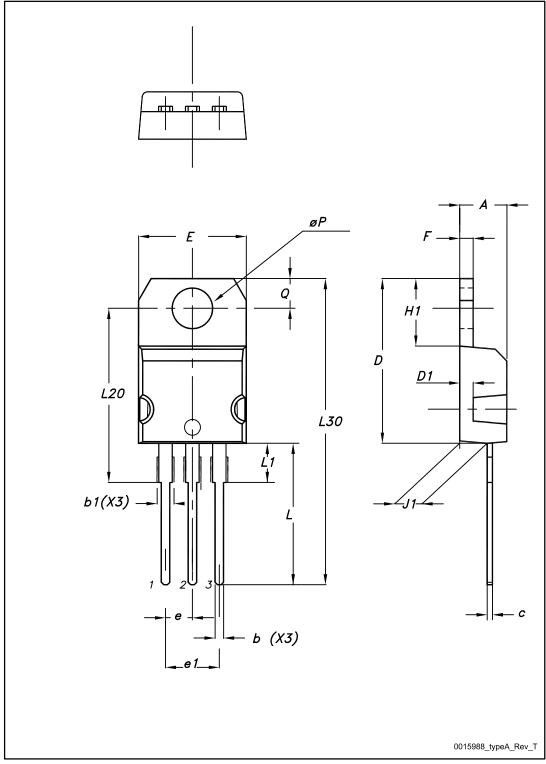
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



4.1 TO-220 type A package information

Figure 22: TO-220 type A package outline



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Package information

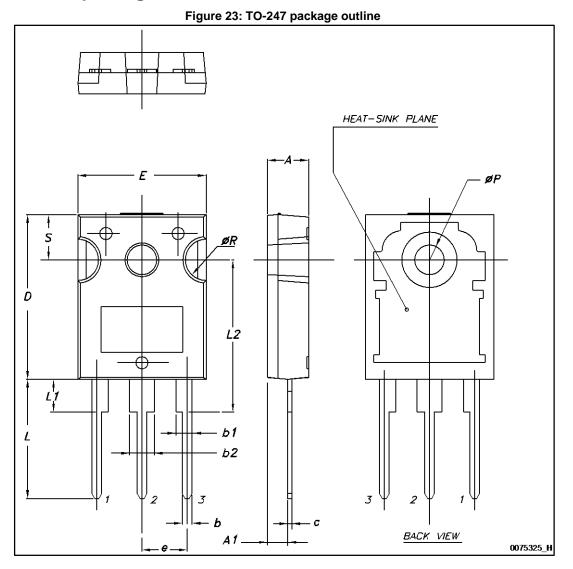
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Max.
Max.
Max.
4.60
0.88
1.70
0.70
15.75
10.40
2.70
5.15
1.32
6.60
2.72
14
3.93
3.85
2.95

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4.2 TO-247 package information





Package information

STP27N60M2-EP, STW27N60M2-EP

Table 10: TO-247 package mechanical data								
Dim	mm.							
Dim.	Min.	Тур.	Max.					
А	4.85		5.15					
A1	2.20		2.60					
b	1.0		1.40					
b1	2.0		2.40					
b2	3.0		3.40					
С	0.40		0.80					
D	19.85		20.15					
E	15.45		15.75					
е	5.30	5.45	5.60					
L	14.20		14.80					
L1	3.70		4.30					
L2		18.50						
ØP	3.55		3.65					
ØR	4.50		5.50					
S	5.30	5.50	5.70					

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5 Revision history

Table 11: Document revision history

Date	Revision	Changes
15-Dec-2015	1	First release.



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